

DOCKET: CU-2417

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application: Takahiro IJIMA et al.

Serial No.: 09/736,864

Filed: December 14, 2000

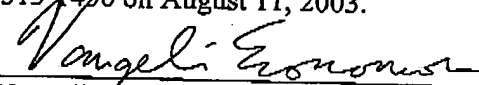
For: INTERCONNECTION SUBSTRATE  
HAVING METAL COLUMNS COVERED BY A  
RESIN FILM AND MANUFACTURING  
METHOD THEREOF

GRP ART UNIT : 2815

Ex.: CHU, C.

**Certification under 37 C.F.R. §1.8(a)**

I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office at the following facsimile number: (703) 746-8812, to the attention of Examiner J. McMillan, and addressed to the Commissioner for Patents, , P.O. Box 1450, Alexandria, VA 22313-1450 on August 11, 2003.

  
Vangelis Economou, Reg. No. 32,341

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CLAIMS SET**

Sir:

In response to the telephone call received on August 9, 2003, please consider the following claims set including all claims 1-14.